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CONFIRMATION NO. 3349

Bib Data Sheet

SERIAL NUMBER 10/735,759	FILING DATE 12/16/2003 RULE	CLASS 257	GROUP ART UNIT 2814	ATTORNEY DOCKET NO. 36856.1185
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APPLICANTS

Kazuhiro Yoshida, Shiga-Ken, JAPAN;

** CONTINUING DATA *****

** FOREIGN APPLICATIONS *****

JAPAN 2002-367764 12/19/2002

Y
IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 03/22/2004

Foreign Priority claimed	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY	SHEETS	TOTAL CLAIMS	INDEPENDENT CLAIMS
35 USC 119 (a-d) conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance	JAPAN	DRAWING 10	16	3
Verified and Acknowledged	Examiner's Signature <i>[Signature]</i>	Initials			

ADDRESS

Keating & Bennett LLP
 Suite 312
 10400 Eaton Place
 Fairfax, VA
 22030

TITLE

Semiconductor device and manufacturing method thereof

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____
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Bib Data Sheet

CONFIRMATION NO. 9818

SERIAL NUMBER 10/810,965	FILING DATE 03/26/2004 RULE	CLASS 257	GROUP ART UNIT 2814	ATTORNEY DOCKET NO. TS01-0413C
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APPLICANTS

Yen-Ming Chen, Hsin-Chu, TAIWAN;

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Li-Chih Chen, Taipei, TAIWAN;

** CONTINUING DATA *****

This application is a CON of 10/060,483 01/30/2002 PAT 6,756,294

** FOREIGN APPLICATIONS *****

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 06/07/2004

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY	SHEETS DRAWING	TOTAL CLAIMS	INDEPENDENT CLAIMS
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	TAIWAN	5	9	2
Verified and Acknowledged	Examiner's Signature Initials				

ADDRESS

George O. Saile
 28 Davis Avenue
 Poughkeepsie , NY
 12603

TITLE

Novel method to improve bump reliability for flip chip device

FILING FEE	FEES: Authority has been given in Paper	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of
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